

ICS8421002I-01

FEMTOCLOCKSTM CRYSTAL-TO-HSTL FREQUENCY SYNTHESIZER

GENERAL DESCRIPTION



The ICS8421002I-01 is a 2 output HSTL Synthesizer optimized to generate Ethernet reference clock frequencies and is a member of the HiPerClocks[™] family of high performance clock solutions from ICS. Using a 25MHz 18pF

parallel resonant crystal, the following frequencies can be generated based on the 2 frequency select pins (F_SEL[1:0]): 156.25MHz, 125MHz and 62.5MHz. The ICS8421002I-01 uses ICS' 3rd generation low phase noise VCO technology and can achieve 1ps or lower typical rms phase jitter, easily meeting Ethernet jitter requirements. The ICS8421002I-01 is packaged in a small 20-pin TSSOP package.

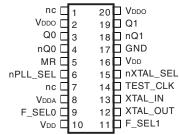
FEATURES

- Two HSTL outputs (VOHmax = 1.4V)
- Selectable crystal oscillator interface or LVCMOS/LVTTL single-ended input
- Supports the following output frequencies: 156.25MHz, 125MHz, 62.5MHz
- VCO range: 560MHz 680MHz
- RMS phase jitter @ 156.25MHz, using a 25MHz crystal (1.875MHz - 20MHz): 0.44ps (typical)
- Power supply modes: Core/Output 3.3V/1.8V
 2.5V/1.8V
- -40°C to 85°C ambient operating temperature

FREQUENCY SELECT FUNCTION TABLE

				Output Frequency
F_SEL1	F_SEL0	M Divider Value	N Divider Value	(25MHz Ref.)
0	0	25	4	156.25
0	1	25	5	125
1	0	25	10	62.5
1	1	not i	used	not used

PIN ASSIGNMENT



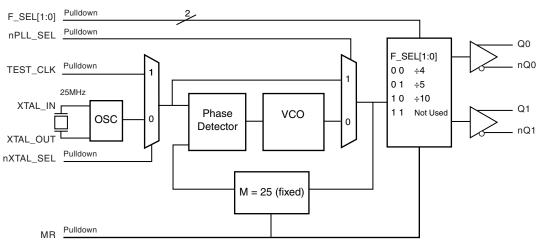
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20-Lead TSSOP

6.5mm x 4.4mm x 0.92mm package body

G Package Top View

BLOCK DIAGRAM



The Preliminary Information presented herein represents a product in prototyping or pre-production. The noted characteristics are based on initial product characterization. Integrated Circuit Systems, Incorporated (ICS) reserves the right to change any circuitry or specifications without notice.



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TABLE 1. PIN DESCRIPTIONS

Number	Name	Ty	/ре	Description
1, 7	nc	Unused		No connect.
2, 20	$V_{\scriptscriptstyle DDO}$	Power		Output supply pins.
3, 4	Q0, nQ0	Ouput		Differential output pair. HSTL interface levels.
5	MR	Input	Pulldown	Active HIGH Master Reset. When logic HIGH, the internal dividers are reset causing the true outputs Qx to go low and the inverted outputs nQx to go high. When logic LOW, the internal dividers and the outputs are enabled. LVCMOS/LVTTL interface levels.
6	nPLL_SEL	Input	Pulldown	Selects between the PLL and TEST_CLK as input to the dividers. When LOW, selects PLL (PLL Enable). When HIGH, deselects the reference clock (PLL Bypass). LVCMOS/LVTTL interface levels.
8	$V_{\scriptscriptstyle DDA}$	Power		Analog supply pin.
9, 11	F_SEL0, F_SEL1	Input	Pulldown	Frequency select pins. LVCMOS/LVTTL interface levels.
10, 16	$V_{_{\mathrm{DD}}}$	Power		Core supply pin.
12, 13	XTAL_OUT, XTAL_IN	Input		Parallel resonant crystal interface. XTAL_OUT is the output, XTAL_IN is the input.
14	TEST_CLK	Input	Pulldown	LVCMOS/LVTTL clock input.
15	nXTAL_SEL	Input	Pulldown	Selects between crystal or TEST_CLK inputs as the the PLL Reference source. Selects XTAL inputs when LOW. Selects TEST_CLK when HIGH. LVCMOS/LVTTL interface levels.
17	GND	Power		Power supply ground.
18, 19	nQ1, Q1	Output		Differential output pair. HSTL interface levels.

NOTE: Pulldown refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ



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ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD} 4.6V

Inputs, V_{II} -0.5V to V_{DD} + 0.5V

Outputs, I_o

Continuous Current 50mA Surge Current 100mA

 $\label{eq:packageThermal Impedance} \begin{array}{ll} {\rm Package\,Thermal\,Impedance,\,\theta_{JA}} & 73.2^{\circ}{\rm C/W}\ (0\ {\rm lfpm}) \\ {\rm Storage\,Temperature,\,T_{\rm STG}} & -65^{\circ}{\rm C\,\,to}\ 150^{\circ}{\rm C} \end{array}$

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

 $\textbf{Table 3A. Power Supply DC Characteristics, } V_{DD} = V_{DDA} = 3.3V \pm 5\%, V_{DDO} = 1.8V \pm 0.2V, TA = -40^{\circ}C \text{ to } 85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V _{DDA}	Analog Supply Voltage		3.135	3.3	3.465	V
V _{DDO}	Output Supply Voltage		3.135	3.3	3.465	V
I _{DD}	Power Supply Current			90		mA
I _{DDA}	Analog Supply Current			10		mA
I _{DDO}	Output Supply Current	No Load		0		mA

Table 3B. Power Supply DC Characteristics, $V_{DD} = V_{DDA} = 2.5V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		2.375	2.5	2.625	V
V_{DDA}	Analog Supply Voltage		2.375	2.5	2.625	V
V _{DDO}	Output Supply Voltage		2.375	2.5	2.625	V
I _{DD}	Power Supply Current			80		mA
I _{DDA}	Analog Supply Current			10		mA
I _{DDO}	Output Supply Current	No Load		0		mA

Table 3C. LVCMOS / LVTTL DC Characteristics, $V_{DD} = V_{DDA} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = -40^{\circ}\text{C}$ to 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V	Input High Vol	togo	$V_{DD} = 3.3V$	2		V _{DD} + 0.3	V
V _{IH}	Input High Vol	lage	$V_{DD} = 2.5V$	1.7		$V_{DD} + 0.3$	V
\/	Input Low Volt	2000	$V_{DD} = 3.3V$	-0.3		0.8	V
V _{IL}	Input Low Volt	age	$V_{DD} = 2.5V$	-0.3		0.7	V
I _{IH}	Input High Current	TEST_CLK, MR, F_SEL0, F_SEL1, nPLL_SEL, nXTAL_SEL	$V_{DD} = V_{IN} = 3.465$ or 2.5V			150	μΑ
I _{IL}	Input Low Current	TEST_CLK, MR, F_SEL0, F_SEL1, nPLL_SEL, nXTAL_SEL	$V_{DD} = 3.465V \text{ or } 2.5V,$ $V_{IN} = 0V$	-150			μΑ

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 $\textbf{Table 3D. HSTL DC Characteristics, V}_{DD} = V_{DDA} = 3.3V \pm 5\%, V_{DDO} = 1.8V \pm 0.2V, TA = -40^{\circ}C \text{ to } 85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		1.0		1.4	٧
V _{OL}	Output Low Voltage; NOTE 1		0		0.4	V
V _{ox}	Output Crossover Voltage; NOTE 2		40		60	%
V _{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.1	V

NOTE 1: Outputs terminated with 50Ω to ground.

NOTE 2: Defined with respect to output voltage swing at a given condition.

 $\textbf{TABLE 3E. HSTL DC CHARACTERISTICS, V}_{DD} = V_{DDA} = 2.5V \pm 5\%, V_{DDO} = 1.8V \pm 0.2V, TA = -40^{\circ}C \text{ to } 85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		1.0		1.4	V
V _{OL}	Output Low Voltage; NOTE 1			0.235		V
V _{ox}	Output Crossover Voltage; NOTE 2		40		60	%
V _{SWING}	Peak-to-Peak Output Voltage Swing			0.9		V

NOTE 1: Outputs terminated with 50Ω to ground.

NOTE 2: Defined with respect to output voltage swing at a given condition.

TABLE 4. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fı	undamenta	I	
Frequency		22.4	25	27.2	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

NOTE: Characterized using an 18pF parallel resonant crystal.



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Table 5A. AC Characteristics, $V_{DD} = V_{DDA} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = -40°C to 85°C to

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
		F_SEL[1:0] = 00	140		170	MHz
f _{out}	Output Frequency	F_SEL[1:0] = 01	112		136	MHz
		F_SEL[1:0] = 10	56		68	MHz
tsk(o)	Output Skew; NOTE 1, 3			TBD		ps
	DMO DI 1311 /D 1	156.25MHz, (1.875MHz - 20MHz)		0.44		ps
<i>t</i> jit(Ø)	RMS Phase Jitter (Random); NOTE 2	125MHz, (1.875MHz - 20MHz)		0.48		ps
	110122	62.5MHz,(1.875MHz - 20MHz)		0.49		ps
t _R / t _F	Output Rise/Fall Time	20% to 80%		450		ps
odc	Output Duty Cycle			50		%

NOTE 1: Defined as skew between outputs at the same supply voltages and with equal load conditions.

Measured at $\rm V_{\rm DDO}/2.$ NOTE 2: Please refer to the Phase Noise Plot.

NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

 $\textbf{Table 5B. AC Characteristics, V}_{DD} = V_{DDA} = 2.5V \pm 5\%, V_{DDO} = 1.8V \pm 0.2V, TA = -40^{\circ}C \text{ to } 85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
		F_SEL[1:0] = 00	140		170	MHz
f _{out}	Output Frequency	F_SEL[1:0] = 01	112		136	MHz
		F_SEL[1:0] = 10	56		68	MHz
tsk(o)	Output Skew; NOTE 1, 3			TBD		ps
	5140 51	156.25MHz, (1.875MHz - 20MHz)		0.41		ps
<i>t</i> jit(Ø)	RMS Phase Jitter (Random); NOTE 2	125MHz, (1.875MHz - 20MHz)		0.49		ps
	110122	62.5MHz,(1.875MHz - 20MHz)		0.50		ps
t _R / t _F	Output Rise/Fall Time	20% to 80%		420		ps
odc	Output Duty Cycle			50		%

NOTE 1: Defined as skew between outputs at the same supply voltages and with equal load conditions.

Measured at V_{DDO}/2.

NOTE 2 Please refer to the Phase Noise Plot.

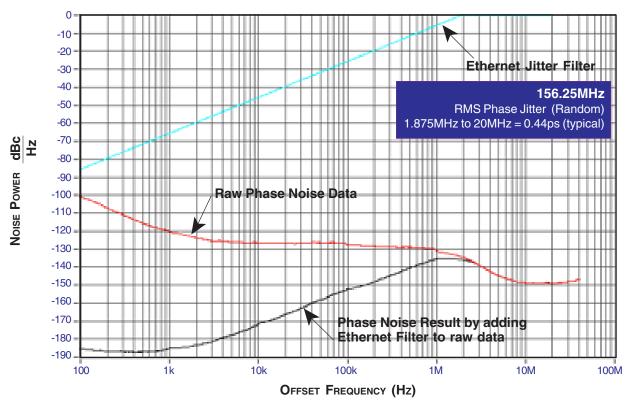
NOTE 3 This parameter is defined in accordance with JEDEC Standard 65.



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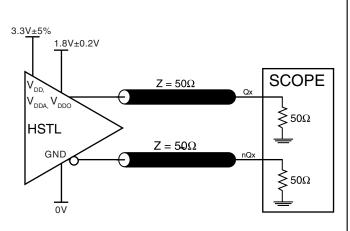
Typical Phase Noise at 156.25MHz

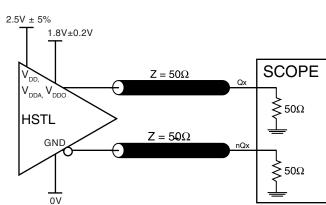


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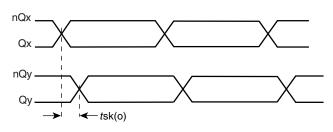
PARAMETER MEASUREMENT INFORMATION

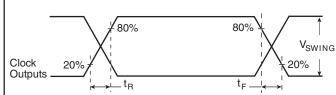




HSTL 3.3V/1.8V OUTPUT LOAD AC TEST CIRCUIT

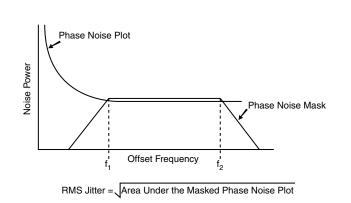
HSTL 2.5V/1.8V OUTPUT LOAD AC TEST CIRCUIT

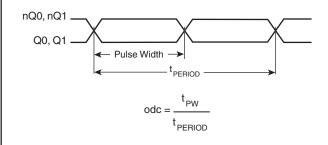




OUTPUT SKEW

OUTPUT RISE/FALL TIME





RMS PHASE JITTER

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



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APPLICATION INFORMATION

Power Supply Filtering Techniques

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS8421002I-01 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. $V_{\rm DD}, V_{\rm DDA},$ and $V_{\rm DDO}$ should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. Figure 1 illustrates how a 10Ω resistor along with a $10\mu F$ and a $.01\mu F$ bypass capacitor should be connected to each $V_{\rm DDA}$.

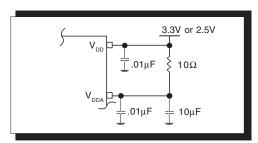
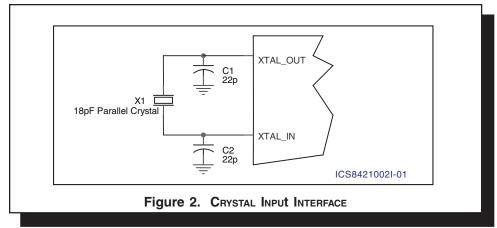


FIGURE 1. POWER SUPPLY FILTERING

CRYSTAL INPUT INTERFACE

The ICS8421002I-01 has been characterized with 18pF parallel resonant crystals. The capacitor values shown in *Figure*

2 below were determined using a 25MHz 18pF parallel resonant crystal and were chosen to minimize the ppm error.





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POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS8421002I-01. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS8421002I-01 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{DD} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = $V_{DD MAX} * I_{DD MAX} = 3.465 V * 100 mA = 346.5 mW$
- Power (outputs)_{MAX} = 32.8mW/Loaded Output pair If all outputs are loaded, the total power is 2 * 32.8mW = 65.6mW

Total Power MAX (3.465V, with all outputs switching) = 346.5mW + 65.6mW = 412.1mW

2. Junction Temperature.

Junction temperature, Ti, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for Tj is as follows: Tj = θ_{IA} * Pd_total + T_A

Tj = Junction Temperature

 θ_{1A} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

 T_{Λ} = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ₁₀ must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 66.6°C/W per Table 6 below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:

 $85^{\circ}\text{C} + 0.412\text{W} * 66.6^{\circ}\text{C/W} = 112.4^{\circ}\text{C}$. This is well below the limit of 125°C .

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

Table 6. Thermal Resistance θ_{JA} for 20-pin TSSOP, Forced Convection

200

500 Single-Layer PCB, JEDEC Standard Test Boards 114.5°C/W 88.0°C/W 98.0°C/W Multi-Layer PCB, JEDEC Standard Test Boards 73.2°C/W 66.6°C/W 63.5°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

 θ_{IA} by Velocity (Linear Feet per Minute)

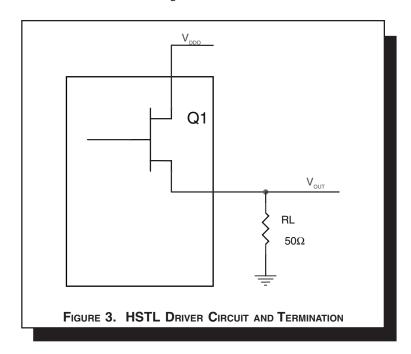
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3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

HSTL output driver circuit and termination are shown in Figure 3.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load.

Pd_H is power dissipation when the output drives high.

Pd_L is the power dissipation when the output drives low.

$$\begin{split} & Pd_H = (V_{OH_MAX}/R_L) * (V_{DD_MAX} - V_{OH_MAX}) \\ & Pd_L = (V_{OL_MAX}/R_L) * (V_{DD_MAX} - V_{OL_MAX}) \end{split}$$

Pd_H =
$$(1V/50\Omega) * (2V - 1V) = 20mW$$

Pd_L = $(0.4V/50\Omega) * (2V - 0.4V) = 12.8mW$

Total Power Dissipation per output pair = Pd_H + Pd_L = 32.8mW



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RELIABILITY INFORMATION

Table 7. $\theta_{\rm JA} {\rm vs.}$ Air Flow Table for 20 Lead TSSOP

θ_{A} by Velocity (Linear Feet per Minute)

 0
 200
 500

 Single-Layer PCB, JEDEC Standard Test Boards
 114.5°C/W
 98.0°C/W
 88.0°C/W

 Multi-Layer PCB, JEDEC Standard Test Boards
 73.2°C/W
 66.6°C/W
 63.5°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS8421002I-01 is: 2951

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PACKAGE OUTLINE - G SUFFIX FOR 20 LEAD TSSOP

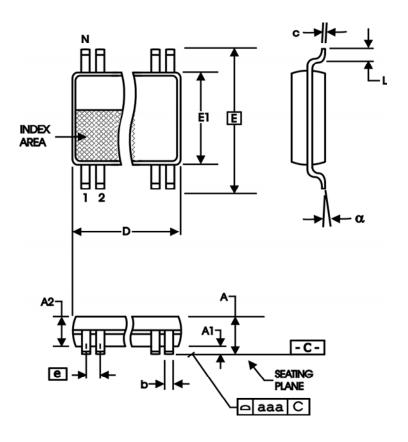


TABLE 7. PACKAGE DIMENSIONS

SYMBOL	Millin	neters
STWIBOL	MIN	MAX
N	2	0
Α		1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
С	0.09	0.20
D	6.40	6.60
E	6.40 E	BASIC
E1	4.30	4.50
е	0.65 E	BASIC
L	0.45	0.75
α	0°	8°
aaa		0.10

Reference Document: JEDEC Publication 95, MO-153



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TABLE 9. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS8421002AGI-01	ICS421002AI01	20 Lead TSSOP	tube	-40°C to 85°C
ICS8421002AGI-01T	ICS421002AI01	20 Lead TSSOP	2500 tape & reel	-40°C to 85°C

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